Unit: mm

MA6X129 (MA129)

Silicon epitaxial planar type

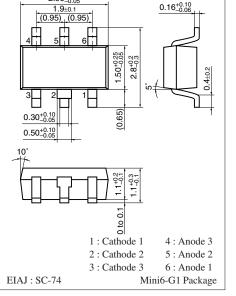
For small power current rectification

Features

- Three isolated elements are contained in one package, allowing high-density mounting
- Allowing high voltage rectification

| Parameter | | Symbol | Rating | Unit |
|---------------------------------|--------|------------------|------------|------|
| Reverse voltage | | V _R | 200 | V |
| Maximum peak reverse voltage | | V _{RM} | 200 | V |
| Output current | Single | I _O | 200 | mA |
| | Triple | | 100 | |
| Repetitive peak forward | Single | I _{FRM} | 600 | mA |
| current | Triple | | 200 | |
| Non-repetitive peak | Single | I _{FSM} | 1 000 | mA |
| forward surge current * | Triple | | 350 | |
| Junction temperature | | Tj | 150 | °C |
| Storage temperature | | T _{stg} | -55 ~ +150 | °C |

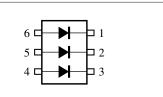
Absolute Maximum Ratings $T_a = 25^{\circ}C$



Marking Symbol: M4F

2.90+0.20

Internal Connection

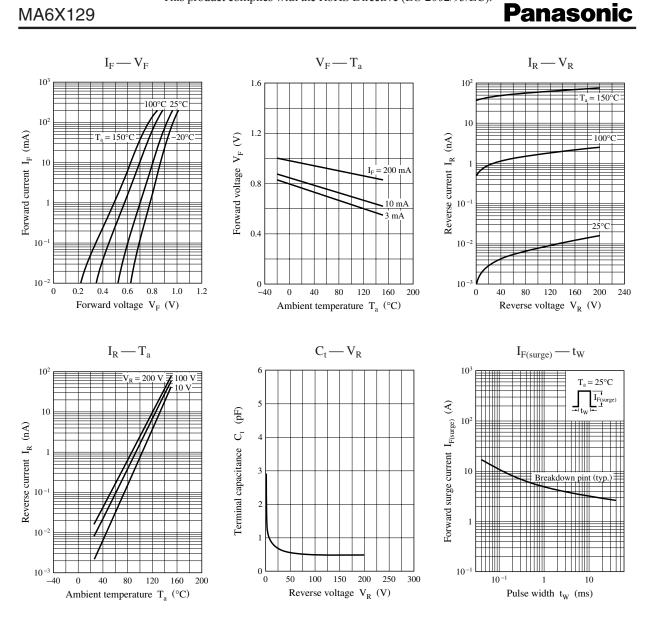


| Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$ | | | | | | | | |
|---|----------------|------------------------|-----|-----|-----|------|--|--|
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit | | |
| Forward voltage | $V_{\rm F}$ | $I_F = 200 \text{ mA}$ | | | 1.2 | V | | |
| Reverse current | I _R | $V_{R} = 200 V$ | | | 200 | nA | | |
| Terminal capacitance | Ct | $V_R = 0 V, f = 1 MHz$ | | 4.5 | | pF | | |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes. 2. Absolute frequency of input and output is 3 MHz.

Note) The part number in the parenthesis shows conventional part number.

MA6X129



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